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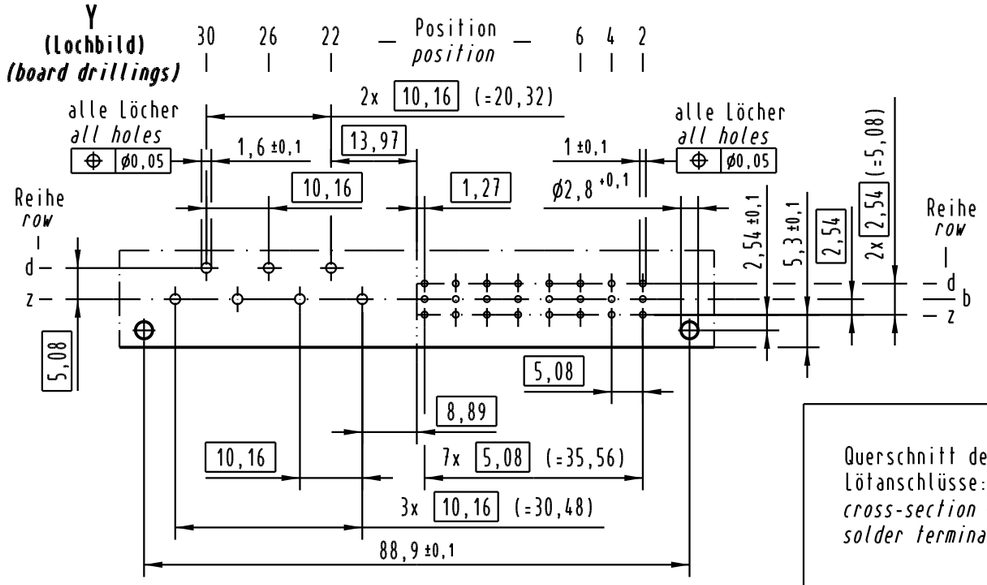
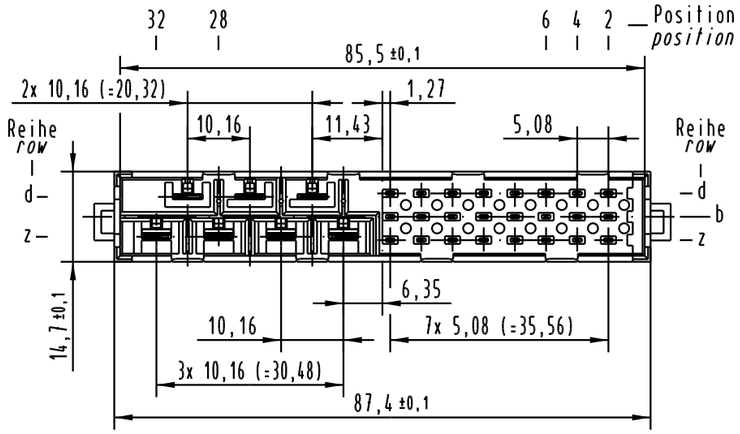
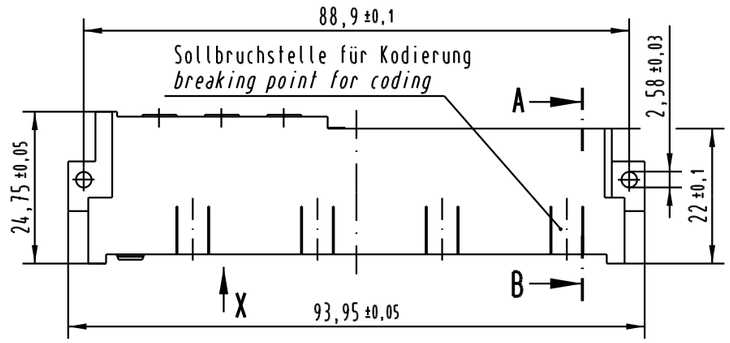
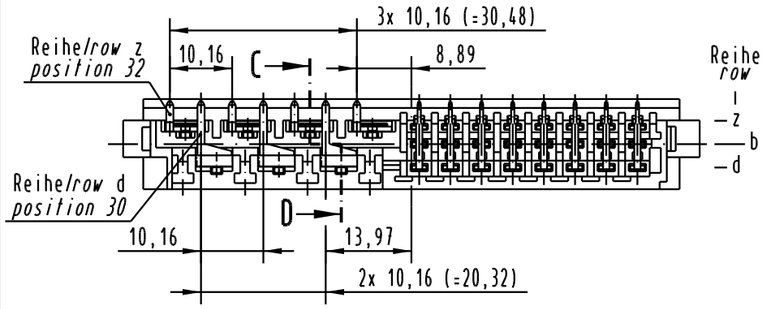
Y
(Lochbild)
(board drillings)



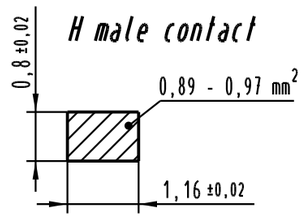


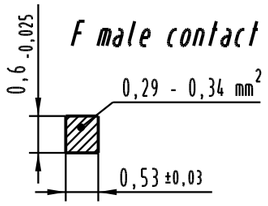


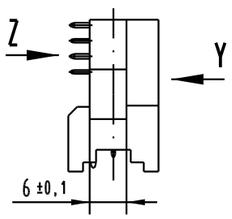


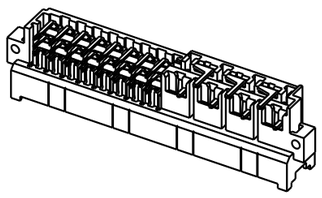
Querschnitt der Lötanschlüsse:
cross-section of solder terminations:

Z
10:1

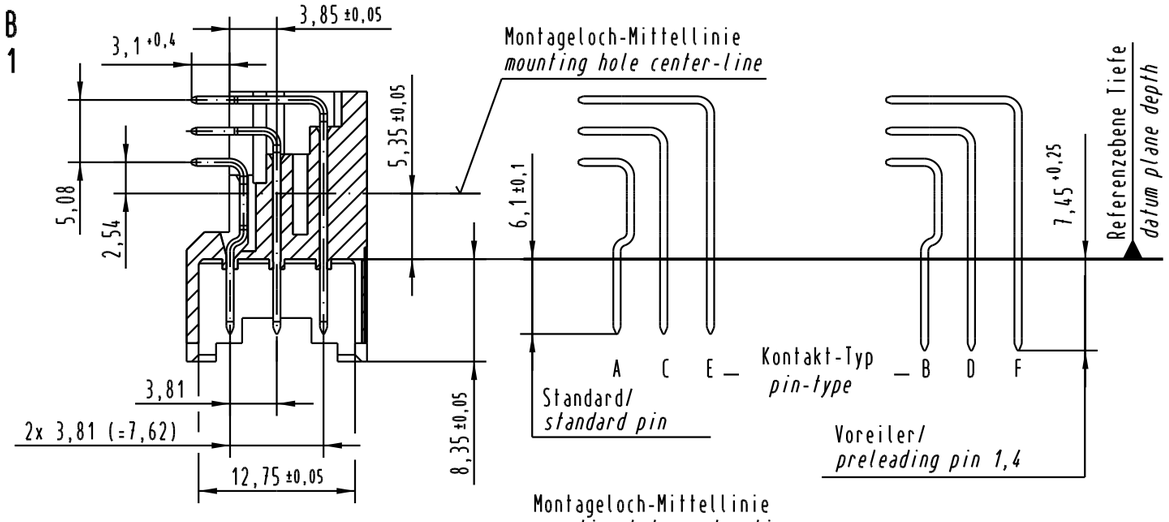




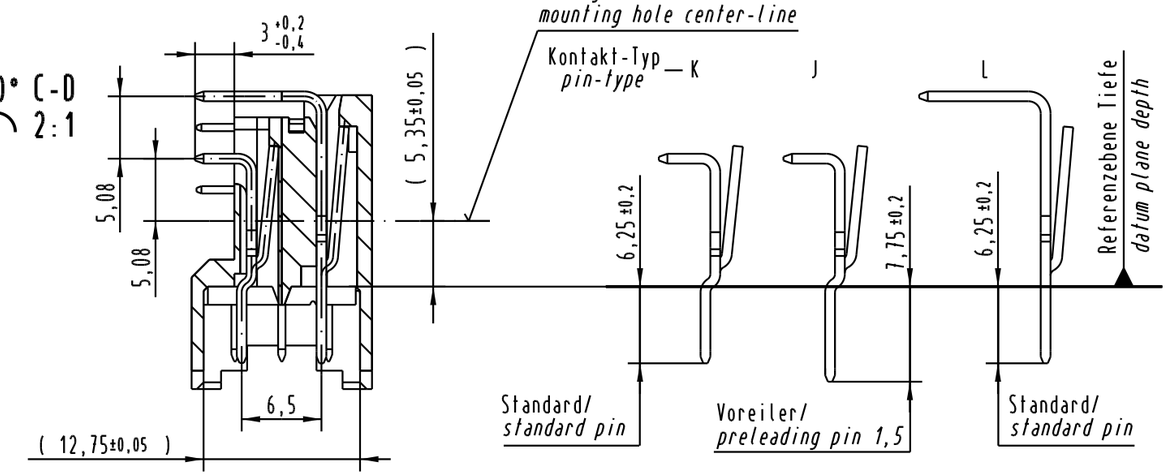




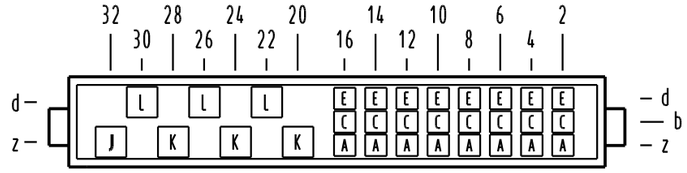
A-B
2:1



90° C-D
2:1



X
Kontaktbelegung
contact loading



-	-	-			
09 06 131 6922	2	*Ag over Ni*	*Sn over Ag over Ni*	*Au over Ni*	*Sn over Ni*
09 06 131 2922	1	*Ag over Ni*	*Sn over Ag over Ni*	*Au over Ni*	*Sn over Ni*
Bestell-Nr. *part-no.*	AFS nach IEC *pl acc. to IEC*	Steckbereich H *contact area H*	Anschlußbereich H *termination area H*	Steckbereich F *contact area F*	Anschlußbereich F *termination area F*

All Dimensions in mm
Original Size DIN A 3

Techn. Character.
ergänzend / *complementary* IEC 60603-2

Nicht tolerierte Maße/*Free size tolerances*
ergänzend / *complementary* IEC 60603-2

	Dat.	Name
Detail.	19.04.04	Hil
Insp.	19.04.05	kfoe
Stand.		

Maßstab/*Scale* 1:1, 2:1, 10:1

Mod.	Dat.	Name
33705	07.06.06	Hage.
32575		

HARTING Electronics GmbH & Co. KG
D-32339 ESPELKAMP

Bauform / *type* MH
male connector F solder angled and H solder angled 31 pol.

TB 09 06 131 x922

Sub.

Blatt/*page* /